Spec No.	DG-134014C
Issue	20-Feb-14

S P E C I F I C A T I O N S

Product Type

ZENIGATA LED

Model No.

GW6DGD**XFC

** : 27, 30, 35, 40, 50

*These specifications contain 20 pages including the cover and appendix. If you have any objections, please contact us before issuing purchasing order.

Preliminary

CUSTOMERS ACCEPTANCE

DATE:

BY:

PRESENTED

BY: T. Uemura Dept. General Manager

REVIEWED BY:

PREPARED BY:

Development Department II Lighting Device Division Electronic Components And Devices Group SHARP CORPORATION

Model No. GW6DGD**XFC



• Handle this document carefully for it contains material protected by international copyright law. Any reproduction, full or in part, of this material is prohibited without the express written permission of the company.

• When using the products covered herein, please observe the conditions written herein and the precautions outlined in the following paragraphs. In no event shall the company be liable for any damages resulting form failure to strictly adhere to these conditions and precautions.

(1) Please do verify the validity of this part after assembling it in customer's products, when customer wants to make catalogue and instruction manual based on the specification sheet of this part.

(2) The products covered herein are designed and manufactured for the following application areas. When using the products covered herein for the equipment listed in paragraph (3), even for the following application areas, be sure to observe the precautions given in Paragraph (3). Never use the products for the equipment listed in Paragraph (4).

- ·Office electronics
- ·Instrumentation and measuring equipment
- Machine tools
- ·Audiovisual equipment
- •Home appliances
- ·Communication equipment other than for trunk lines

(3) These contemplating using the products covered herein for the following equipment which demands high reliability, should first contact a sales representative of the company and then accept responsibility for incorporating into the design fail-safe operation, redundancy, and other appropriate measures for ensuring reliability and safety of the equipment and the overall system.

• Control and safety devices for airplanes, trains, automobiles, and other

- transportation equipment
- · Mainframe computers
- traffic control systems
- ·Gas leak detectors and automatic cutoff devices
- ·Rescue and security equipment
- ·Other safety devices and safety equipment, etc.

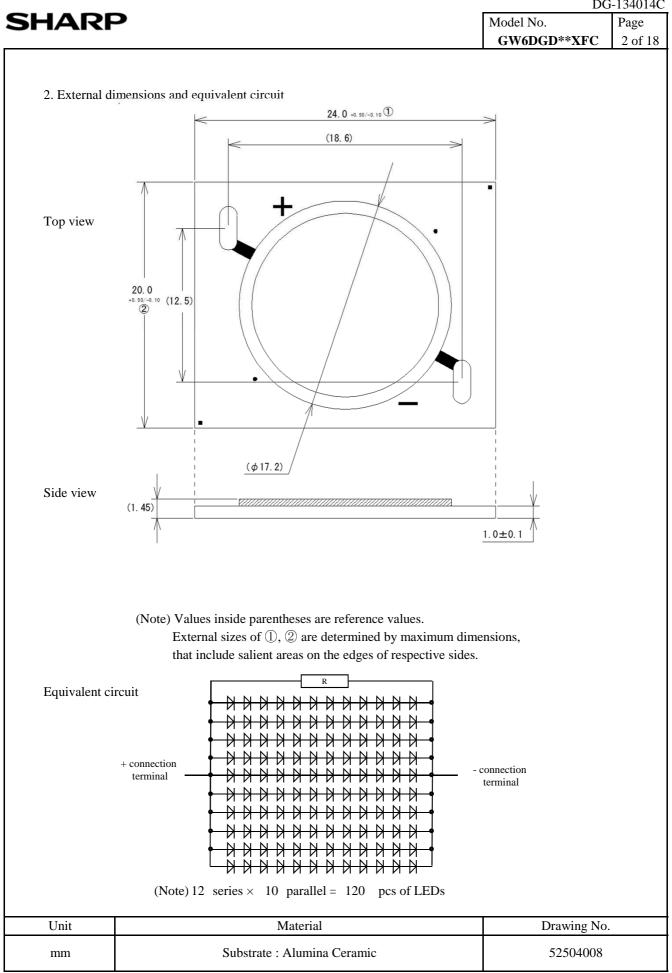
(4) Do not use the products covered herein for the following equipment which

demands extremely high performance in terms of functionality, reliability, or accuracy.

- ·Aerospace equipment
- ·Communications equipment for trunk lines
- ·Control equipment for the nuclear power industry
- ·Medical equipment related to life support, etc.
- (5) please direct all queries and comments regarding the interpretation of the above four Paragraphs to a sales representative of the company.

Please direct all queries regarding the products covered herein to a sales representative of the company.

			i-134(
HARP		Model No. GW6DGD**XFC	Pag 1 o
		GWODGD ATC	10
GW6DGD**XFC	specifications		
1. Application			
These specifications apply to the light emitting diode [LED module (InGaN Blue LED chip + Phosphor)]		DOD ^{***} AFC.	
Main application : Lighting			
2. External dimensions and equivalent circuit	Refer to Page 2.		
2. Detings and characteristics	Defer to Dece 2	5	
3. Ratings and characteristics 3-1. Absolute maximum ratings	Refer to Page 3-	5.	
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5-1. Applied standard			
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6-1. Chromaticity rank table			
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	-		
8. Characteristics diagram (TYP.)	Refer to Page 18		



3. Ratings and characteristics

3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power Dissipation *1,4	Р	46.2	W
Forward Current *1,4	I _F	1200	mA
Reverse Voltage *2,4	V _R	-15	V
Operating Temperature *3	T _{opr}	$-30 \sim +100$	°C
Storage Temperature	T _{stg}	- 40 ~ + 100	°C
Junction Temperature	Tj	145	°C

*1 Power dissipation and forward current are the values when the module temperature is set lower than the rating by using an adequate heat sink.

*2 The maximum rating of reverse voltage is assumed, after considering the voltage that occur due to initial connection error that may occur suddenly.

(Not dealing with the possibility of always-on reverse voltage.)

*3 Operating temperature is the Case temperature Tc

(Refer to measuring point for case temperature in the next page.)

Refer to "Derating curve" in the next page as for operating current.

*4 $T_c = 25 \ ^{\circ}C$

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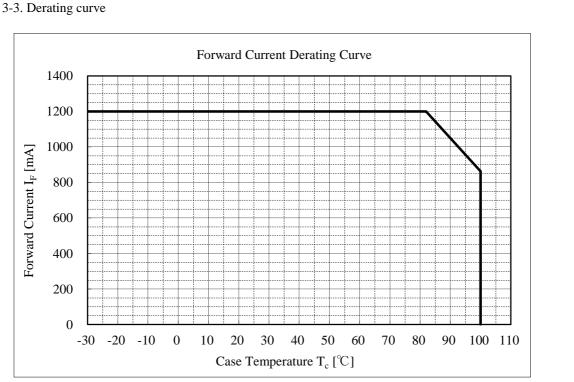
3-2. Electro-optical characteristics

							(<u>Tj</u> = 9	0 °C)
**	Item	Symbol	0	Conditio	on	MIN.	TYP.	MAX.	Unit
common	Forward Voltage *5	VF	$I_F =$	950	mA	32.5	(35.0)	38.5	V
	Luminous Flux *6	Φ				2510	(2790)	-	lm
	Chromaticity Coordinates *7	x				-	(0.4610)	-	-
27	Chromaticity Cooldinates 7	у	$I_F =$	950	mA	-	(0.4150)	-	-
	Color Temperature	-				-	(2720)	-	Κ
	General Color Rendering Index *8	Ra				90	(93)	-	-
	Luminous Flux*6	Φ				2650	(2950)	-	lm
	Chromaticity Coordinates *7	x				-	(0.4370)	-	-
30	Chromaticity Coordinates 7	у	I _F =	950	mA	-	(0.4030)	-	-
	Color Temperature	-				-	(3000)	-	K
	General Color Rendering Index *8	Ra				90	(93)	-	-
	Luminous Flux*6	Φ				2700	(3010)	-	lm
	Chromaticity Coordinates *7	x				-	(0.4090)	-	-
35	Chromaticity Coordinates 7	у	I _F =	950	mA	-	(0.3930)	-	-
	Color Temperature	-				-	(3440)	-	K
	General Color Rendering Index *8	Ra				90	(93)	-	-
	Luminous Flux*6	Φ				2780	(3090)	-	lm
	Chromaticity Coordinates *7	x				-	(0.3820)	-	-
40	Chromaticity Coordinates 7	у	I _F =	950	mA	-	(0.3800)	-	-
	Color Temperature	-				-	(3980)	-	K
	General Color Rendering Index *8	Ra				90	(92)	-	-
	Luminous Flux*6	Φ				2810	(3130)	-	lm
	Chromotiaity Coordinates *7	x				-	(0.3480)	-	-
50	Chromaticity Coordinates *7	у	I _F =	950	mA	-	(0.3600)	-	-
	Color Temperature	-				-	(4920)	-	K
	General Color Rendering Index *8	Ra				-	(90)	-	-

(Note) Values inside parentheses are shown for reference purpose only.

- *5 (After 20 ms drive, Measurement tolerance: \pm 3 %)
- *6 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Measurement tolerance: ± 10 %)
- *7 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Measurement tolerance: ± 0.005)
- *8 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Measurement tolerance: ± 2)

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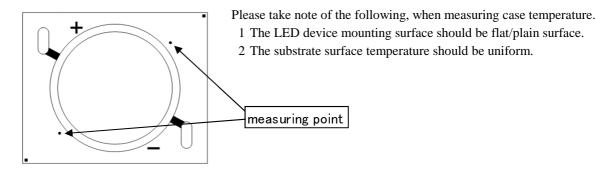


(Note) To keep the case temperature lower than the rating, enough heat-radiation performance needs to be secured by using an adequate heat sink (refer to section 8-③).

For soldering connection, please evaluate in your usage environment to make sure soldering reliability. (Above derating curve is specified to LED device, not for soldering connection) And please consider to avoid physical stress between wire and substrate, and some protection like silicon bond on top of soldered wire is recommended.

Please ensure the maintenance of heat radiation does not exceed case temperature over the rating in operation.

(Measuring point for case temperature)



Thermal Resistance: 1.3 °C/W(Typical value)

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4. Reliability

The reliability of products shall be satisfied with items listed below.

4-1.7	Fest items and test condit	tions	Co	nfidence le	vel: 90 %
No.	Test item	Test conditions	Samples	Defective	LTPD
			n	С	(%)
1	Temperature Cycle	- 40 °C(30 min) \sim + 100 °C(30 min), 100 cycles			
			11	0	20
2	Temperature Humidity	$T_{stg} = +60 ^{\circ}\text{C}, \text{RH} = 90 ^{\circ}\text{, Time} = 1000 \text{ h}$			
	Storage		11	0	20
3	High Temperature	$T_{stg} = +100^{\circ}C$, Time = 1000 h			
	Storage		11	0	20
4	Low Temperature	$T_{stg} = -40 \text{ °C}, \text{ Time} = 1000 \text{ h}$			
	Storage		11	0	20
5	Steady State Operating	$Tc = 90 \degree C$, $IF = 950 \text{ mA}$, $Time = 1000 \text{ h}$			
	Life		11	0	20
6	Shock	Acceleration: 15000 m/s^2 , Pulse width: 0.5 ms			
		Direction: 3 directions (X, Y and Z)			
		3 trials in each direction	5	0	50
7	Vibration	Frequency: 100 to 2000 Hz for 4 minutes per trial			
		Acceleration: 200 m/s ²			
		Direction: 3 directions (X, Y and Z)			
		4 trials in each direction	5	0	50

4-2. Failure criteria

No.	Parameter	Symbol	Failure criteria
1	Forward Voltage	V _F	$V_F > Initial value \times 1.1$
2	Luminous Flux	Φ	$\Phi \le$ Initial value $\times 0.7$

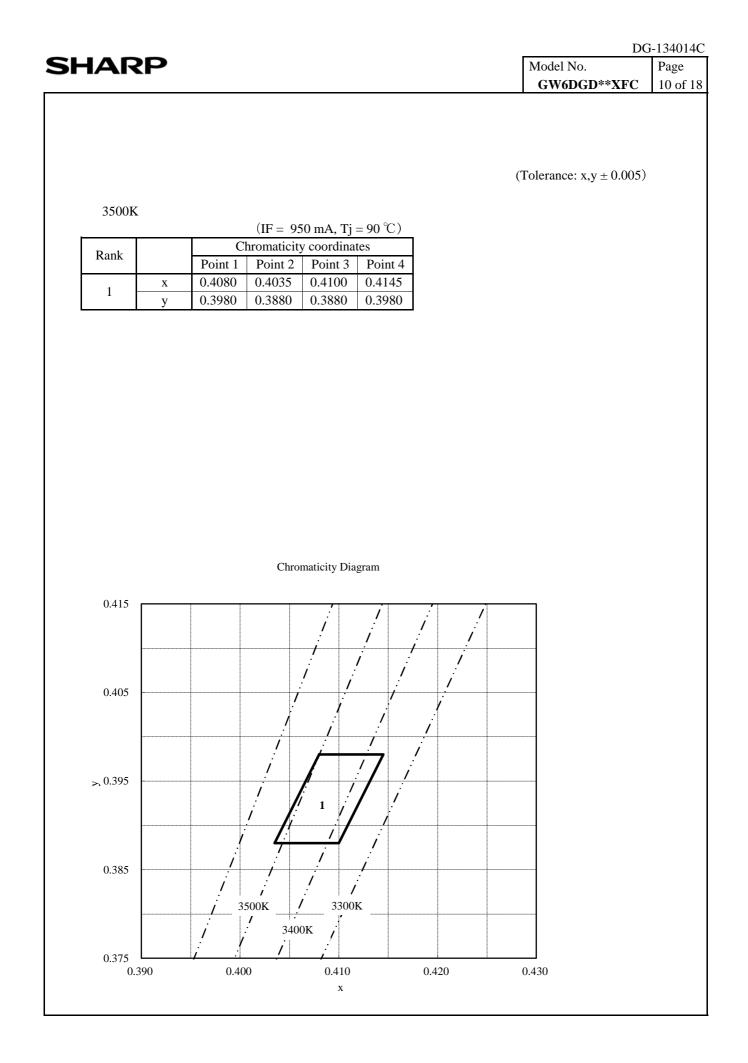
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łΑ	IRP	Ν	Model No.		Page
			GW6DGD**X	KFC	7 of 1
5-1. A IS 5-2. S	ality level Applied standard 302859-1 Sampling inspecti single normal sa	on mpling plan, level S-4.			
5-3. I	·	and defect criteria			
No.	Item	Defect criteria	Classification	AQL	
No. 1	Item No radiation	Defect criteria No light emitting	Major		
	No radiation			AQL 0.1	_
	No radiation Electro-optical	No light emitting Not conforming to the specification	Major		_
1 2	No radiation	No light emitting	Major		_
1	No radiation Electro-optical	No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values) Not conforming to the specified dimensions	Major		_
1 2 3	No radiation Electro-optical characteristics External dimensions	No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2)	Major defect		_
1 2	No radiation Electro-optical characteristics External	No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values) Not conforming to the specified dimensions	Major defect Minor	0.1	_
1 2 3	No radiation Electro-optical characteristics External dimensions	No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2)	Major defect		_
1 2 3	No radiation Electro-optical characteristics External dimensions	No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2) Nonconformity observed in product appearance is determined	Major defect Minor	0.1	_
1 2 3	No radiation Electro-optical characteristics External dimensions	No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2) Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by.	Major defect Minor	0.1	_
1 2 3	No radiation Electro-optical characteristics External dimensions	No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2) Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by. <if above="" any="" arises="" criterion="" mentioned="" of="" question="" regardless=""></if>	Major defect Minor defect	0.1	
1 2 3	No radiation Electro-optical characteristics External dimensions	No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2) Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by. <if above="" any="" arises="" criterion="" mentioned="" of="" question="" regardless=""> ■ Foreign material, scratch, or bubble at emitting area: 0.8 mm φ</if>	Major defect	0.1	

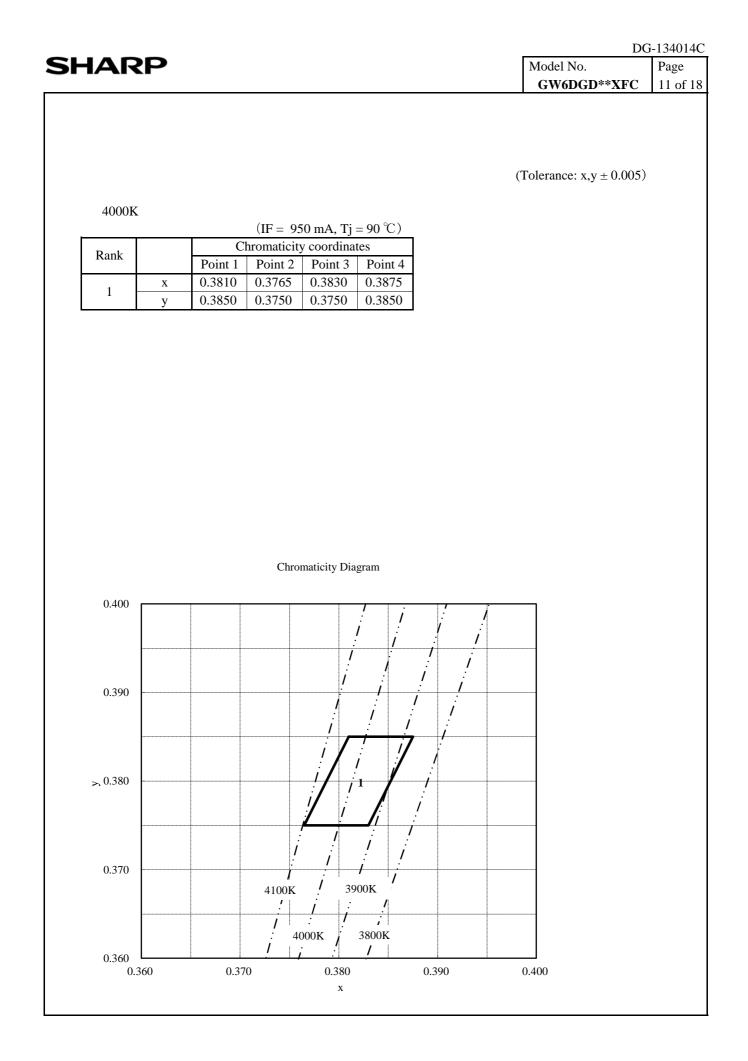
(Note) Products with removable foreign material attached on are not determined to be defective.

(Note) Substrate cracks that do not effect the electrical/optical charecteristics are not determined to be defective.

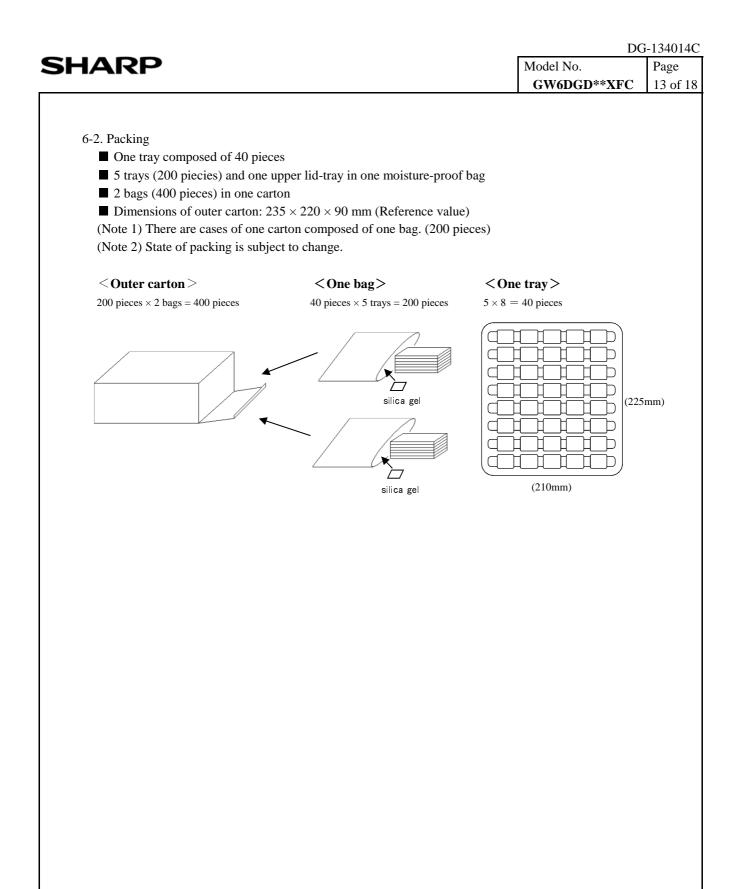
GW60GD**XFC 6. Supplements (Tolerance: x,y ± 0.005) 2700K (TE = 950 mA, Tj = 90 °C) (TE = 950 mA, Tj = 90 °C) Mark model Chromaticity coordinates 1 x 0.4600 0.4555 0.4620 0.4665 1 y 0.4200 0.4100 0.4200 0.4100 0.4200											G-1340
6. Supplements 6.1. Chromaticity rank table (TF = 950 mA, Tj = 90 °C) Note that the two terms of the terms of terms of the terms of the terms of terms		Ρ									Page
									GW6D0	GD**XFC	8 of
	5. Supplem	ents									
	6 1 Chror		ant table					C	Toloron oou		
$(F = 950 \text{ mA}, Tj = 90 ^{\circ} C)$ $\hline Rank $	5-1. Chron	naticity r	ank table					(rolerance:	$x,y \pm 0.003$	
Rank Chromaticity coordinates 1 Note Point 1 Point 2 Point 3 Point 4 1 X 0.4000 0.4555 0.4665 0.4665 1 y 0.4200 0.4100 0.4200 0.4200 0.4100 0.4100 0.4100 0.4200 0.4200	2700K										
Rain Point 1 Point 2 Point 3 Point 4 1 x 0.4600 0.4525 0.4620 0.4665 y 0.4200 0.4100 0.4100 0.4200	T										
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						GW6DGD**XFC	9 of 18
3000K Rank 1 —	Point x 0.436 y 0.408	Chromaticity1Point 200.4315	0 mA, Tj = 90 °C coordinates Point 3 Point 0.4380 0.442 0.3980 0.408	4 5	(To	elerance: x,y ± 0.005)	
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0.425		Chrom		7			
				7/			





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						(Tolerance: x,y	v + 0.005	
						· · · · · · · · · · · · · · · · · · ·	(,,,,,,,,_,,_,_,_) = 0.0000)	
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0.370 → 0.360 0.350	30		5000K	: 4800K			0.370		



IARP	DG-134014 Model No. Page
	GW6DGD**XFC 14 of 1
	Gwobab Arc 1401
6-3. Label	
1)Outer carton	
Following label is attached on outer carton.	
(Note 3) Label format is subjected to change.	1) Lot No. indication
	XX 11 B 25
SHIPMENT TABLE	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
PART No. GW6DGD**XFC ← Model number	① Production plant code
(GW6DGD**XFCM) ←(Model number+suffix code)	② Shipping year (Year last 2 digits)
QUANTITY : 400 \leftarrow QuantityLOT No.XX11B25XX102 \leftarrow Lot No.	③ Shipping month
RANK 1 ←Rank	(from January to December in ABC order)
SHARP CORPORATION R.C. ←Production country	(4) Shipping date $(01 \sim 31)$
·MADE IN PHILIPPINES	*Notation may be different
MADE IN INDONESIA	
2)Moisture-Proof bag	
Following label is attached on moisture-proof bags.	
(Note 3) Label format is subjected to change.	1) Lot No. indication
	XX 1 9 G 11 123 A
SHIPMENT TABLE	
PART No. GW6DGD**XFC ← Model number (GW6DGD**XFCW) ← (Model number+suffix code)	① Production plant code (PHL (MAT):50, IDN (SSI):0
(GW6DGD#*XFCM) ←(Model number+suffix code) QUANTITY: 200 RANK 1 ←Quantity and rank	② Shipping year (Year last digit)
LOT No. 5020G2064A ←Lot No.	③ Shipping month $(1 \sim 9 \text{ or O, N, D})$
	④ Fixed code G
MADE IN XXXXXXXXXX $(\mathbf{R}, \mathbf{G}) \leftarrow Production country$	(5) Shipping date $(01 \sim 31)$
-MADE IN PHILIPPINES SHAP LARE -MADE IN INDONESIA	6 Serial No.
	⑦ Backup code A
	*Notation may be different
A Indication minted on meduat	
6-4. Indication printed on product Model No. and control No. are indicated on substrate su	rface
Model No. and control No. are indicated on substrate su	frace.
) Model No.	•
Abbreviated Model No ' 6DGD**XFC ' is indicated.	
) Control No.	
Indicated as follows;	
M 12 B 11 - 1	
0 2 3 4 5	
① Production plant code (to be indicated alphabetically)	
	Model No. Control No.
PHL(MAT): M, $IDN(SSI): Y$	
 ② Year of production (the last two figures of the year) 	
2 Year of production (the last two figures of the year)	onding to A)
② Year of production (the last two figures of the year)③ Month of production	onding to A)
 ② Year of production (the last two figures of the year) ③ Month of production (to be indicated alphabetically with January correspondence) 	onding to A)

IARP	Model No.	G-1340 Page
	GW6DGD**XFC	15 o
7. Precautions		
① Storage conditions		
Please follow the conditions below. • Before opened: Temperature 5 \sim 30 °C, Relative humidity less th	an 60 %	
(Before opened LED should be used within a year)		
• After opened: Temperature 5 \sim 30 °C, Relative humidity less that	n 60 %.	
(Please apply soldering within 1 week)		
• After opened LED should be kept in an aluminum moisture proof b	ag with a moisture	
absorbent material (silica gel).		
• Avoid exposing to air with corrosive gas.		
If exposed, electrode surface would be damaged, which may affect	soldering.	
② Usage conditions		
This product is not designed for the use under any of the following of		
Please carefully check the performance and reliability well enough i following conditions;	n case of using under any of the	
• In a place with a lot of moisture, dew condensation, briny air, and c	corrosive gas.	
(Cl, H2S, NH3, SO2, NOX, etc.)		
•Under the direct sunlight, outdoor exposure, and in a dusty place.		
•In water, oil, medical fluid, and organic solvent.		
Please do not use component parts like rubber which may contain su	lfur (gasket packing, adhesive mat	erial,
etc.).		
Please note that any strong acidic or alcoholic elements could effect The best and light released from the LED davise, could generate hel		
The heat and light released from the LED device, could generate half which may have adverse impact on the module. Before using please		
③ Heat radiation and Installation		
If forward current (IF) is applied to single-state module at any curre	nt, there is a risk of damaging LEI)
or emitting smoke, due to increase in temperature.		
Equip with specified heat radiator(heat sink), and avoid heat being st		
Material of substrate is alumina ceramic. If installed inappropriately,		
occur, which may result in board cracks or lighting defects due to o	verheat. Please take particular not	ice for
installation. Refer to the following cautions while installing the LED device on h	aat cink	
• Apply thermolysis adhesive, adhesive sheet or peculiar connector w		
In case of applying adhesive or adhesive sheet only, check the effect		ng.
If LED comes off from heat radiator, unusual temperature rise entail	•	-
device deterioration, coming off of solder at leads, and emitting sm	oke, along with LED device deffect	cts.
•When LED device is mechanically fixed or locked, Please take into	consideration regarding the method	od of
attachment due to fail from stress.		

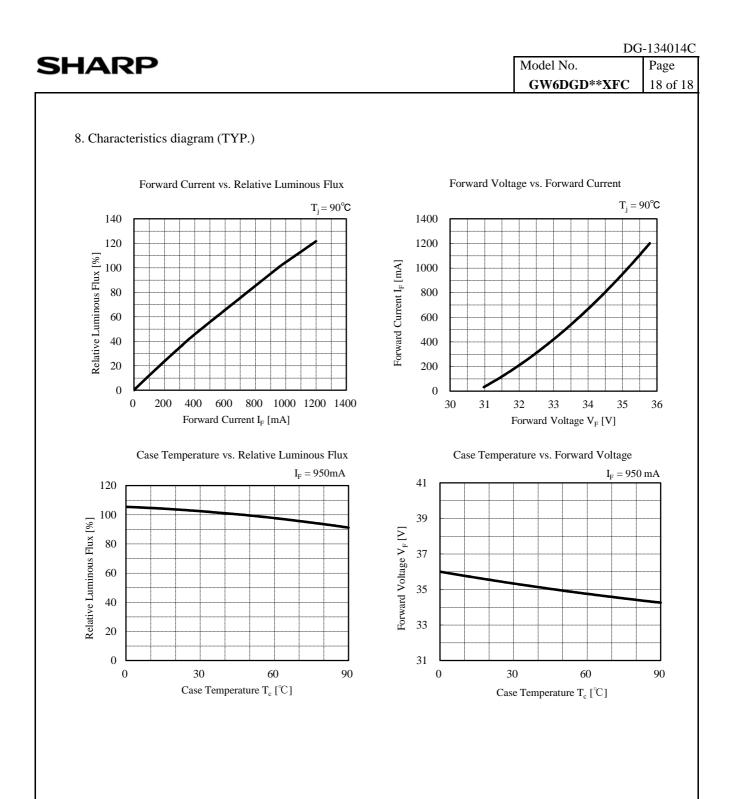
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 Please apply appropriate stress and design carefully, when fixing the LED excessive or uneven stress could break LED device's substrate. Avoid convexly uneven boards. Convex board is subject to substrate cracking or debasement of heat release. It is recommended to apply adhesive or adhesive sheet with high thermal of for radiation of heat effectively. Please take care about the influence of color change of adhesive or adhesive period, which may affect light output or color due to change of reflectance. Any excessive or uneven stress on the ceramic substrate could break the suppoper/uniform stress is applied on the substrate, when fixing the LED de When fixing the LED device with a holder, please take note if any excessi when pressing the substrate with holder. Due to this, the gap may arise be adhesive material, which may affect the heat dissipation of the device. Do not touch resin part including white resin part on the surface of LED. 	e. onductivity ve sheet in initial and long from backside. ubstrate. Please design such vice using a holder. ve or uneven stress is appli tween LED device and	ı that,
No light emission may occur due to damage of resin or cutting wire of Ll	-	
When using tweezers, please handle by ceramic substrate part and avoid tou		
For mounting, please handle by side part of ceramic or the specified area sh	own below.	
(10.0) (10.0) (4.8) (4.8)	ea	
• The outer edges of the substrate may be uneven in some cases. Please aver points, while designing for installation.	id choosing these areas as	fixing
• In case of using heat radiation sheet or heat radiation adhesive, light reflect materials may influence the output of LED device. Especially, the color c	-	

- Secure the solderwettability on whole solder pad and leads.
- · During the soldering process, put the ceramic board on materials whose conductivity is poor enough not to radiate heat of soldering.
- •Warm up (with using a heated plate) the substrate is recommended before soldering.

(preheat condition: 100 $^\circ \text{C} \sim$ 150 $^\circ \text{C}$, within 60 sec)

- •Avoid touching any part of resin with soldering iron.
- This product is not designed for reflow and flow soldering.
- Avoid such lead arrangement as applying stress to solder-applied area.
- Please do not detach solder and make re-solder.
- •Please solder evenly on each electrode.
- •Please prevent flux from touching to resin.
- ·Do the soldering on stable stand. Avoid soldering on moving or vibrating objects.
- •Please avoid touching the soldering unit to resin.

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5 Static electricity			
This product is subject to static electricity, so ta	ke measures like wearing wrig	st hand to cone with it	
Install circuit protection device to drive circuit,		st build to cope with it.	
instant encourt protection dovice to drive encourt,	n neeessary.		
6 Drive method			
• Any reverse voltage cannot be applied to LED	s when they are in operation	or not.	
Design a circuit so that any flow of reverse or f	orward voltage can not be app	plied to LEDs	
when they are out of operation.			
•Module is composed of LEDs connected in bo	th series and parallel.		
Constant voltage power supply runs off more the	an specified current amount of	due to lowered VF	
caused by temperature rise. Constant current po	ower supply is recommended t	to drive.	
•Be cautious while putting on/off the power sup	ply, as excess current, excess	voltage or reverse voltage	ge may g
injucted to the device in some cases.			
⑦ Cleaning			
Avoid cleaning, since LED device may be effec	ted in some cases by cleaning		
<i>c,</i>		,	
⑧ Color-tone variation			
Chromaticity of this product is monitored by int	egrating sphere right after the	e operation.	
Chromaticity varies depending on measuring me	ethod, light spread condition,	or ambient temperature.	
Please verify your actual conditions before use.			
(9) Safety			
•Looking directly at LEDs for a long time may re-	esult in hurting your eyes		
•In case that excess current (over ratings) is supp		phenomena including	
abnormal heat generation, emitting smoke, or c		phonomena meraamg	
Take appropriate measures to excess current an			
• In case of solder connecting method, there is a	-	v heat.	
Please fix the leads in such case to protect from			ict.
•Please confirm the safety standards or regulatio	_	, , , , , , , , , , , , , , , , , , ,	
•Please be careful with substrate edges, that may	**		
① Other cautions Cuerrentee equations to the quality.	standards montioned in the an	adifications	
Guarantee covers the compliance to the quality showever it does not cover the compatibility with	-		
and usage environment.	r application of the end-use, in	including asseniory	
In case any quality problems occurred in the app	lication of end-use details w	ill be separately discusse	h
and determined between the parties hereto.	sheation of end-use, details w	in be separately discusse	u
and determined between the parties hereto.			



(Note) Characteristics data shown here are for reference purpose only. (Not guaranteed data)